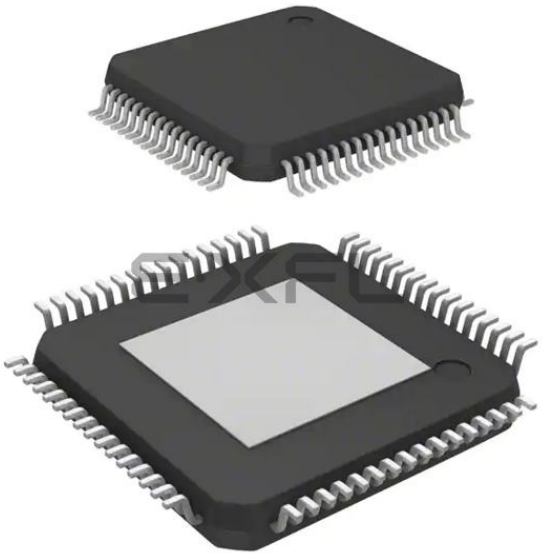
Infineon Technologies - XMC1404F064X0128AAXUMA1 Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	ARM® Cortex®-M0
Core Size	32-Bit Single-Core
Speed	48MHz
Connectivity	CANbus, I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, I²S, LED, POR, PWM, WDT
Number of I/O	48
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 12x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP Exposed Pad
Supplier Device Package	PG-LQFP-64-6
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/xmc1404f064x0128aaxuma1

XMC1400 AA-Step

Microcontroller Series
for Industrial Applications

XMC1000 Family

ARM® Cortex®-M0
32-bit processor core

Data Sheet

V1.3 2016-10

Microcontrollers

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Table 1 Features of XMC1400 Device Types[1)] (cont'd)

Features		XMC1401-Q048	XMC1401-F064	XMC1402-T038	XMC1402-Q040	XMC1402-Q048	XMC1402-Q064	XMC1402-F064	XMC1403-Q040	XMC1403-Q048	XMC1403-Q064	XMC1404-Q048	XMC1404-Q064	XMC1404-F064
Analog	ADC (kernels / analog inputs)	2 / 12	2 / 12	2 / 12	2 / 12	2 / 12	2 / 12	2 / 12	2 / 12	2 / 12	2 / 12	2 / 12	2 / 12	2 / 12
	ACMP	-	-	3	3	4	4	4	-	-	-	4	4	4
GPIOs		34	48	26	27	34	48	48	27	34	48	34	48	48
GPIs		8	8	8	8	8	8	8	8	8	8	8	8	8
Packages		VQFN-48	LQFP-64	TSSOP-38	VQFN-40	VQFN-48	VQFN-64	LQFP-64	VQFN-40	VQFN-48	VQFN-64	VQFN-48	VQFN-64	LQFP-64

1) Features that are not included in this table are available in all the derivatives

1.2 Ordering Information

The ordering code for an Infineon microcontroller provides an exact reference to a specific product. The code "XMC1<DDD>-<Z><PPP><T><FFFF>" identifies:

- <DDD> the derivatives function set
- <Z> the package variant
  - T: TSSOP
  - Q: VQFN
  - F: LQFP
- <PPP> package pin count
- <T> the temperature range:
  - F: -40°C to 85°C
  - X: -40°C to 105°C
- <FFFF> the Flash memory size in Kbytes.

For ordering codes for the XMC1400 please contact your sales representative or local distributor.

This document describes several derivatives of the XMC1400 series, some descriptions may not apply to a specific product. Please see **Table 2**.

For simplicity the term **XMC1400** is used for all derivatives throughout this document.

Table 3 XMC1400 Chip Identification Number (cont'd)

Derivative	Value	Marking
XMC1402-Q048X0064	00014083 07FF00FF 1E071FF7 100F900F 00000D00 00001000 00011000 10204083_H	AA
XMC1402-Q048X0128	00014083 07FF00FF 1E071FF7 100F900F 00000D00 00001000 00021000 10204083_H	AA
XMC1402-Q048X0200	00014083 07FF00FF 1E071FF7 100F900F 00000D00 00001000 00033000 10204083_H	AA
XMC1402-Q064X0064	00014093 07FF00FF 1E071FF7 100F900F 00000D00 00001000 00011000 10204083_H	AA
XMC1402-Q064X0128	00014093 07FF00FF 1E071FF7 100F900F 00000D00 00001000 00021000 10204083_H	AA
XMC1402-Q064X0200	00014093 07FF00FF 1E071FF7 100F900F 00000D00 00001000 00033000 10204083_H	AA
XMC1402-F064X0064	000140A3 07FF00FF 1E071FF7 100F900F 00000D00 00001000 00011000 10204083_H	AA
XMC1402-F064X0128	000140A3 07FF00FF 1E071FF7 100F900F 00000D00 00001000 00021000 10204083_H	AA
XMC1402-F064X0200	000140A3 07FF00FF 1E071FF7 100F900F 00000D00 00001000 00033000 10204083_H	AA
XMC1403-Q040X0064	00014043 07CF00FF 1E071FF7 00B00000 00000D00 00001000 00011000 10204083_H	AA
XMC1403-Q040X0128	00014043 07CF00FF 1E071FF7 00B00000 00000D00 00001000 00021000 10204083_H	AA
XMC1403-Q040X0200	00014043 07CF00FF 1E071FF7 00B00000 00000D00 00001000 00033000 10204083_H	AA
XMC1403-Q048X0064	00014083 07CF00FF 1E071FF7 00B00000 00000D00 00001000 00011000 10204083_H	AA
XMC1403-Q048X0128	00014083 07CF00FF 1E071FF7 00B00000 00000D00 00001000 00021000 10204083_H	AA
XMC1403-Q048X0200	00014083 07CF00FF 1E071FF7 00B00000 00000D00 00001000 00033000 10204083_H	AA
XMC1403-Q064X0064	00014093 07CF00FF 1E071FF7 00B00000 00000D00 00001000 00011000 10204083_H	AA
XMC1403-Q064X0128	00014093 07CF00FF 1E071FF7 00B00000 00000D00 00001000 00021000 10204083_H	AA

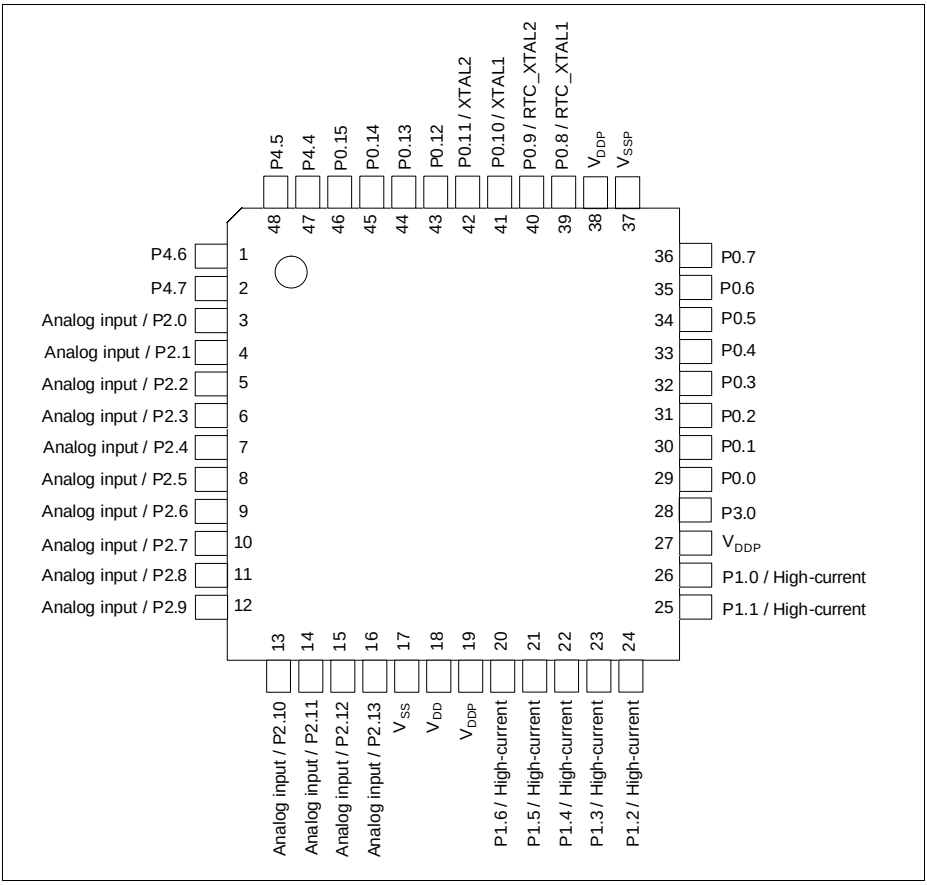

Figure 8 XMC1400 PG-VQFN-48-73 Pin Configuration (top view)

2.2.4 Hardware Controlled I/O Function Description

The following general building block is used to describe the hardware I/O and pull control functions of each PORT pin:

Table 8 Hardware Controlled I/O Function Description

Function	Outputs	Inputs	Pull Control	
	HWO0	**HWI0**	**HW0_PD**	**HW0_PU**
P0.0	MODB.OUT	MODB.INA		
Pn.y			$\overline{\text{MODC.OUT}}$	MODC.OUT

By Pn_HWSEL, it is possible to select between different hardware “masters” (HWO0/HWI0, HWO1/HWI1). The selected peripheral can take control of the pin(s). Hardware control overrules settings in the respective port pin registers. Additional hardware signals HW0_PD/HW1_PD and HW0_PU/HW1_PU controlled by the peripherals can be used to control the pull devices of the pin.

Please refer to the **Hardware Controlled I/O Functions** table for the complete hardware I/O and pull control function mapping.

Table 9 Port I/O Functions (cont'd)

Function	Outputs									Inputs										
	ALT1	ALT2	ALT3	ALT4	ALT5	ALT6	ALT7	ALT8	ALT9	Input	Input	Input	Input	Input	Input	Input	Input	Input	Input	Input
P3.2	BCCU0.OUT2	USIC1_CH1.SCLKOUT		LEDTS2.COL1	CCU80.OUT11	ACMP2.OUT	USIC1_CH0.SCLKOUT	CCU81.OUT11	CCU41.OUT2							USIC1_CH0.DX3C	USIC1_CH0.DX4C	USIC1_CH1.DX3D	USIC1_CH1.DX4D		ERU1.2A1
P3.3	BCCU0.OUT5	USIC1_CH0.DOUT0		LEDTS2.COL2	CCU80.OUT10	ACMP0.OUT	USIC1_CH1.SELO0	CCU81.OUT10	CCU41.OUT3							USIC1_CH0.DX0E			USIC1_CH1.DX2A		ERU1.1A3
P3.4	BCCU0.OUT6	USIC1_CH0.DOUT0	USIC1_CH0.SCLKOUT	LEDTS2.COL3	CCU80.OUT01	USIC1_CH1.MCLKOUT	USIC1_CH1.SELO1	CCU81.OUT01								USIC1_CH0.DX0F	USIC1_CH0.DX1E		USIC1_CH1.DX2B		ERU1.2A3
P4.0	BCCU0.OUT0	ERU1.PDOUT0	LEDTS2.COL5	ERU1.GOUT0	CCU40.OUT0	ACMP1.OUT	USIC1_CH1.SELO1	CCU81.OUT10	CCU41.OUT0		CCU40.IN0BA	CCU41.IN0AC	CCU80.IN0AU			USIC1_CH0.DX3D	USIC1_CH0.DX4D				
P4.1	BCCU0.OUT8	ERU1.PDOUT1	LEDTS2.COL4	ERU1.GOUT1	CCU40.OUT1	ACMP3.OUT	USIC1_CH1.SELO2	CCU81.OUT11	CCU41.OUT1		CCU40.IN1BA	CCU41.IN1AC	CCU80.IN1AU		POSIF1.IN0B	USIC1_CH0.DX5C					
P4.2	BCCU0.OUT4	ERU1.PDOUT2	CCU81.OUT20	ERU1.GOUT2	CCU40.OUT2	ACMP2.OUT	USIC1_CH1.SELO3	CCU81.OUT12	CCU41.OUT2		CCU40.IN2BA	CCU41.IN2AC	CCU80.IN2AU	CCU81.IN1AB	POSIF1.IN1B	USIC1_CH0.DX5D					
P4.3	BCCU0.OUT5	ERU1.PDOUT3	CCU81.OUT21	ERU1.GOUT3	CCU40.OUT3	ACMP0.OUT	USIC1_CH0.SCLKOUT	CCU81.OUT13	CCU41.OUT3		CCU40.IN3BA	CCU41.IN3AC	CCU80.IN3AU		POSIF1.IN2B		USIC1_CH0.DX1B				
P4.4	BCCU0.OUT0	LEDTS2.LINE0		LEDTS1.COLA	CCU80.OUT00	USIC1_CH0.DOUT0		CCU81.OUT00	CCU41.OUT0			CCU41.IN0AV				USIC1_CH0.DX0C		USIC1_CH1.DX5F			ERU1.0A2
P4.5	BCCU0.OUT8	LEDTS2.LINE1		LEDTS1.COL6	CCU80.OUT01	USIC1_CH0.DOUT0	USIC1_CH0.SCLKOUT	CCU81.OUT01	CCU41.OUT1			CCU41.IN1AV				USIC1_CH0.DX0D	USIC1_CH0.DX1C				ERU1.1A2
P4.6	BCCU0.OUT2	LEDTS2.LINE2	CCU81.OUT10	LEDTS1.COL5	CCU80.OUT10		USIC1_CH0.SCLKOUT	CCU81.OUT02	CCU41.OUT2			CCU41.IN2AV		CCU81.IN0AB			USIC1_CH0.DX1D				ERU1.2A2
P4.7	BCCU0.OUT5	LEDTS2.LINE3	CCU81.OUT11	LEDTS1.COL4	CCU80.OUT11		USIC1_CH0.SELO0	CCU81.OUT03	CCU41.OUT3			CCU41.IN3AV					USIC1_CH0.DX2A				ERU1.0A3
P4.8	BCCU0.OUT7	LEDTS2.LINE4	LEDTS2.COL3	LEDTS1.COL3	CCU80.OUT30	CCU40.OUT0	USIC1_CH0.SELO1	CCU81.OUT30	CAN.N1_TXD		CCU40.IN0AV	CCU41.IN0BA					USIC1_CH0.DX2B			CAN.N1_RXDC	
P4.9	BCCU0.OUT3	LEDTS2.LINE5	LEDTS2.COL2	LEDTS1.COL2	CCU80.OUT31	CCU40.OUT1	USIC1_CH0.SELO2	CCU81.OUT31	CAN.N1_TXD		CCU40.IN1AV	CCU41.IN1BA					USIC1_CH0.DX2C			CAN.N1_RXDD	

Table 10 Hardware I/O Controlled Functions

Function	Outputs	Outputs	Inputs	Inputs	Pull Control	Pull Control	Pull Control	Pull Control
	HWO0	HWO1	HWI0	HWI1	HW0_PD	HW0_PU	HW1_PD	HW1_PU
P1.3		USIC0_CH0.DOUT3		USIC0_CH0.HWIN3	$\overline{\text{BCCU0.OUT5}}$	BCCU0.OUT5		
P1.4					$\overline{\text{BCCU0.OUT6}}$	BCCU0.OUT6		
P1.5					$\overline{\text{BCCU0.OUT7}}$	BCCU0.OUT7		
P1.6					$\overline{\text{BCCU0.OUT8}}$	BCCU0.OUT8		
P1.7								
P1.8								
P2.0					$\overline{\text{BCCU0.OUT1}}$	BCCU0.OUT1		
P2.1					$\overline{\text{BCCU0.OUT6}}$	BCCU0.OUT6		
P2.2					$\overline{\text{BCCU0.OUT0}}$	BCCU0.OUT0	$\overline{\text{CCU40.OUT3}}$	CCU40.OUT3
P2.3					$\overline{\text{ACMP2.OUT}}$	ACMP2.OUT		
P2.4					$\overline{\text{BCCU0.OUT8}}$	BCCU0.OUT8		
P2.5					$\overline{\text{ACMP1.OUT}}$	ACMP1.OUT		
P2.6					$\overline{\text{BCCU0.OUT2}}$	BCCU0.OUT2	$\overline{\text{CCU40.OUT3}}$	CCU40.OUT3
P2.7					$\overline{\text{BCCU0.OUT8}}$	BCCU0.OUT8	$\overline{\text{CCU40.OUT3}}$	CCU40.OUT3
P2.8					$\overline{\text{BCCU0.OUT1}}$	BCCU0.OUT1	$\overline{\text{CCU40.OUT2}}$	CCU40.OUT2
P2.9					$\overline{\text{BCCU0.OUT7}}$	BCCU0.OUT7	$\overline{\text{CCU40.OUT2}}$	CCU40.OUT2
P2.10					$\overline{\text{BCCU0.OUT4}}$	BCCU0.OUT4		
P2.11					$\overline{\text{BCCU0.OUT5}}$	BCCU0.OUT5		
P2.12					$\overline{\text{BCCU0.OUT3}}$	BCCU0.OUT3	$\overline{\text{CCU41.OUT0}}$	CCU41.OUT0
P2.13					$\overline{\text{BCCU0.OUT4}}$	BCCU0.OUT4	$\overline{\text{CCU41.OUT2}}$	CCU41.OUT2
P3.0								
P3.1		USIC1_CH0.DOUT3		USIC1_CH0.HWIN3				
P3.2		USIC1_CH0.DOUT2		USIC1_CH0.HWIN2				
P3.3		USIC1_CH0.DOUT1		USIC1_CH0.HWIN1				
P3.4		USIC1_CH0.DOUT0		USIC1_CH0.HWIN0				
P4.0								
P4.1								
P4.2								
P4.3								

Table 10 Hardware I/O Controlled Functions

Function	Outputs	Outputs	Inputs	Inputs	Pull Control	Pull Control	Pull Control	Pull Control
	HWO0	HWO1	HWI0	HWI1	HW0_PD	HW0_PU	HW1_PD	HW1_PU
P4.4	LEDTS2. EXTENDED0		LEDTS2.TSIN0	LEDTS2.TSIN0	Reserved for LEDTS Scheme A: pull-down disabled always	Reserved for LEDTS Scheme A: pull-down enabled always	Reserved for LEDTS Scheme B: pull-up enabled and pull-down disabled, and vice versa	
P4.5	LEDTS2. EXTENDED1		LEDTS2.TSIN1	LEDTS2.TSIN1				
P4.6	LEDTS2. EXTENDED2		LEDTS2.TSIN2	LEDTS2.TSIN2				
P4.7	LEDTS2. EXTENDED3		LEDTS2.TSIN3	LEDTS2.TSIN3				
P4.8	LEDTS2. EXTENDED4		LEDTS2.TSIN4	LEDTS2.TSIN4				
P4.9	LEDTS2. EXTENDED5		LEDTS2.TSIN5	LEDTS2.TSIN5				
P4.10	LEDTS2. EXTENDED6		LEDTS2.TSIN6	LEDTS2.TSIN6				
P4.11	LEDTS2. EXTENDED7		LEDTS2.TSIN7	LEDTS2.TSIN7				

3.2 DC Parameters

3.2.1 Input/Output Characteristics

Table 16 provides the characteristics of the input/output pins of the XMC1400.

Note: These parameters are not subject to production test, but verified by design and/or characterization.

Note: Unless otherwise stated, input DC and AC characteristics, including peripheral timings, assume that the input pads operate with the standard hysteresis.

Table 16 Input/Output Characteristics (Operating Conditions apply)

Parameter	Symbol		Limit Values		Unit	Test Conditions
			Min.	Max.		
Output low voltage on port pins (with standard pads)	V_{OLP}	CC	–	1.0	V	I_{OL} = 11 mA (5 V) I_{OL} = 7 mA (3.3 V)
			–	0.4	V	I_{OL} = 5 mA (5 V) I_{OL} = 3.5 mA (3.3 V)
Output low voltage on high current pads	V_{OLP1}	CC	–	1.0	V	I_{OL} = 50 mA (5 V) I_{OL} = 25 mA (3.3 V)
			–	0.32	V	I_{OL} = 10 mA (5 V)
			–	0.4	V	I_{OL} = 5 mA (3.3 V)
Output high voltage on port pins (with standard pads)	V_{OHP}	CC	V_{DDP} - 1.0	–	V	I_{OH} = -10 mA (5 V) I_{OH} = -7 mA (3.3 V)
			V_{DDP} - 0.4	–	V	I_{OH} = -4.5 mA (5 V) I_{OH} = -2.5 mA (3.3 V)
Output high voltage on high current pads	V_{OHP1}	CC	V_{DDP} - 0.32	–	V	I_{OH} = -6 mA (5 V)
			V_{DDP} - 1.0	–	V	I_{OH} = -8 mA (3.3 V)
			V_{DDP} - 0.4	–	V	I_{OH} = -4 mA (3.3 V)
Input low voltage on port pins (Standard Hysteresis)	V_{ILPS}	SR	–	0.19 × V_{DDP}	V	CMOS Mode (5 V, 3.3 V & 2.2 V)
Input high voltage on port pins (Standard Hysteresis)	V_{IHPS}	SR	0.7 × V_{DDP}	–	V	CMOS Mode (5 V, 3.3 V & 2.2 V)

Table 17 ADC Characteristics (Operating Conditions apply)[1)] (cont'd)

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Gain settings	G_{IN} CC		1		–	GNCTRxz.GAINy = 00_B (unity gain)
			3		–	GNCTRxz.GAINy = 01_B (gain g1)
			6		–	GNCTRxz.GAINy = 10_B (gain g2)
			12		–	GNCTRxz.GAINy = 11_B (gain g3)
Sample Time	t_{sample} CC	5	–	–	1 / f_{ADC}	V_{DD} = 5.0 V, f_{ADCI} = 48 MHz
		3	–	–	1 / f_{ADC}	V_{DD} = 5.0 V, f_{ADCI} = 32 MHz
		3	–	–	1 / f_{ADC}	V_{DD} = 3.3 V, f_{ADCI} = 32 MHz
		30	–	–	1 / f_{ADC}	V_{DD} = 2.0 V, f_{ADCI} = 32 MHz
Conversion time in fast compare mode	t_{CF} CC		9		1 / f_{ADC}	3)
Conversion time in 12-bit mode	t_{C12} CC		20		1 / f_{ADC}	3)
Maximum sample rate in 12-bit mode[4)]	f_{C12} CC	–	–	f_{ADC} / 42.5	–	1 sample pending
		–	–	f_{ADC} / 62.5	–	2 samples pending
Conversion time in 10-bit mode	t_{C10} CC		18		1 / f_{ADC}	3)
Maximum sample rate in 10-bit mode[4)]	f_{C10} CC	–	–	f_{ADC} / 40.5	–	1 sample pending
		–	–	f_{ADC} / 58.5	–	2 samples pending
Conversion time in 8-bit mode	t_{C8} CC		16		1 / f_{ADC}	3)

3.2.3 Out of Range Comparator (ORC) Characteristics

The Out-of-Range Comparator (ORC) triggers on analog input voltages (V_{AIN}) above V_{DDP} on selected input pins (ORCx.AIN) and generates a service request trigger (ORCx.OUT).

Note: These parameters are not subject to production test, but verified by design and/or characterization.

Table 18 Out of Range Comparator (ORC) Characteristics (Operating Conditions apply; V_{DDP} = 3.0 V - 5.5 V; C_L = 0.25pF)

Parameter	Symbol		Values			Unit	Note / Test Condition
			Min.	Typ.	Max.		
DC Switching Level	V_{ODC}	CC	–	–	180	mV	$V_{AIN} \geq V_{DDP} + V_{ODC}$
Hysteresis	V_{OHYS}	CC	15	–	54	mV	
Always detected Overvoltage Pulse	t_{OPDD}	CC	103	–	–	ns	$V_{AIN} \geq V_{DDP}$ + 150 mV
			88	–	–	ns	$V_{AIN} \geq V_{DDP}$ + 350 mV
Never detected Overvoltage Pulse	t_{OPDN}	CC	–	–	21	ns	$V_{AIN} \geq V_{DDP}$ + 150 mV
			–	–	11	ns	$V_{AIN} \geq V_{DDP}$ + 350 mV
Detection Delay	t_{ODD}	CC	39	–	132	ns	$V_{AIN} \geq V_{DDP}$ + 150 mV
			31	–	121	ns	$V_{AIN} \geq V_{DDP}$ + 350 mV
Release Delay	t_{ORD}	CC	44	–	240	ns	$V_{AIN} \leq V_{DDP}$; V_{DDP} = 5 V
			57	–	340	ns	$V_{AIN} \leq V_{DDP}$; V_{DDP} = 3.3 V
Enable Delay	t_{OED}	CC	–	–	300	ns	ORCCTRL.ENORCx = 1

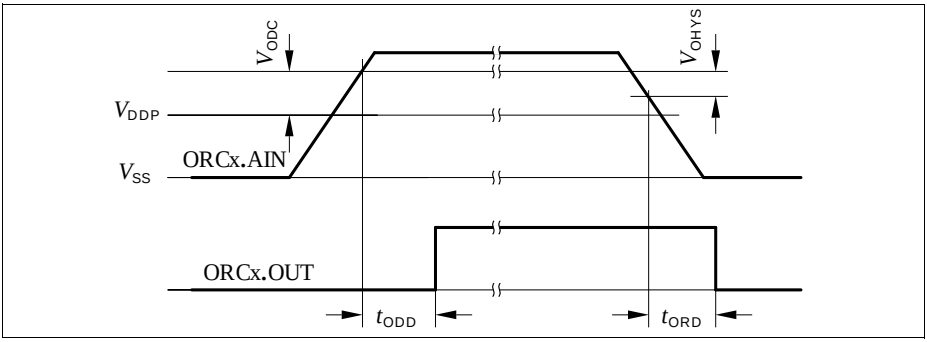

Figure 13 ORCx.OUT Trigger Generation

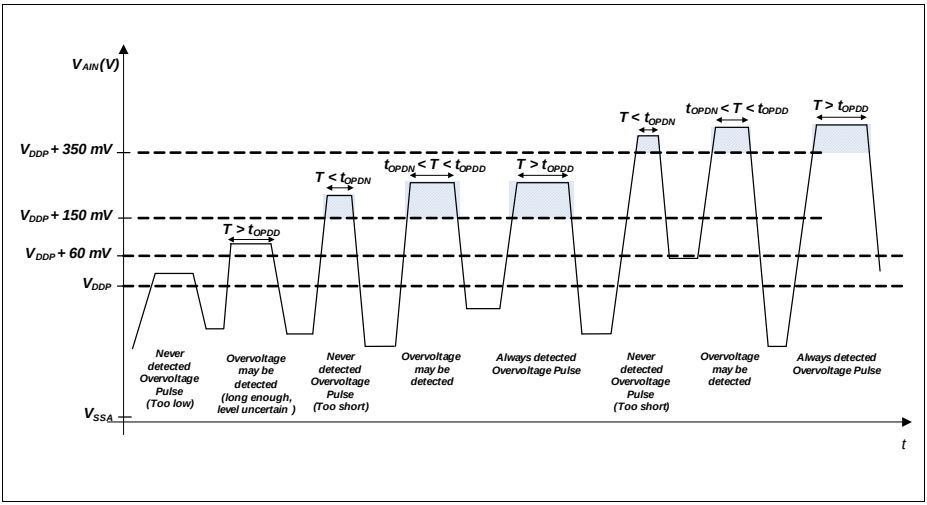

Figure 14 ORC Detection Ranges

3.2.6 Oscillator Pins

Note: It is strongly recommended to measure the oscillation allowance (negative resistance) in the final target system (layout) to determine the optimal parameters for the oscillator operation. Please refer to the limits specified by the crystal or ceramic resonator supplier.

Note: These parameters are not subject to production test, but verified by design and/or characterization.

The oscillator pins can be operated with an external crystal/resonator (see **Figure 15**) or in direct input mode (see **Figure 16**).

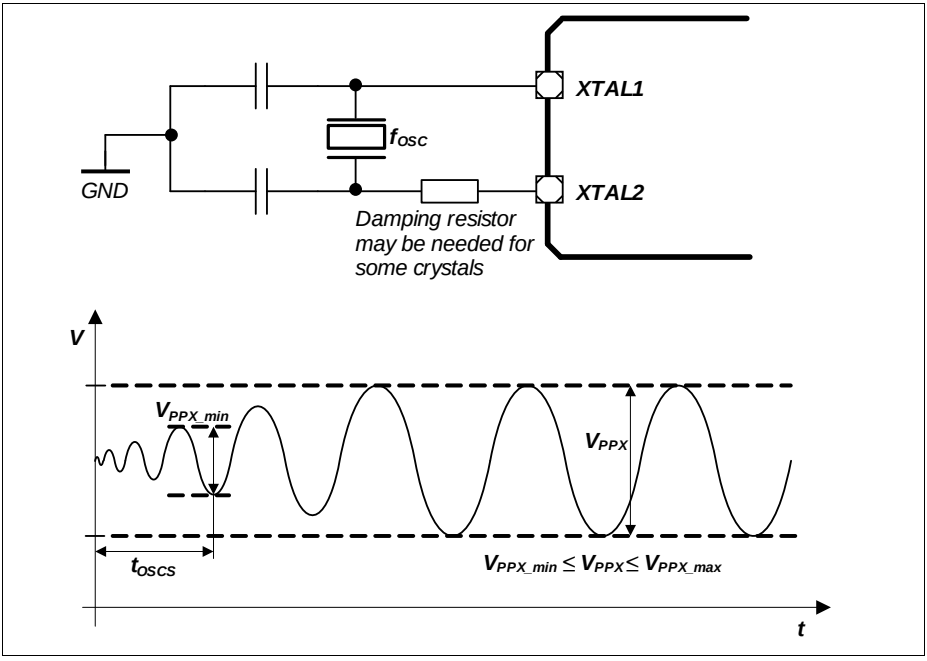

Figure 15 Oscillator in Crystal Mode

3.2.7 Power Supply Current

The total power supply current defined below consists of a leakage and a switching component.

Application relevant values are typically lower than those given in the following tables, and depend on the customer's system operating conditions (e.g. thermal connection or used application configurations).

Note: These parameters are not subject to production test, but verified by design and/or characterization.

Table 23 Power Supply parameter table; V_{DDP} = 5V

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.[1]	Max.		
Active mode current Peripherals enabled f_{MCLK} / f_{PCLK} in MHz[2]	I_{DDPAE} CC	–	14.1	20	mA	48 / 96
		–	9.8	–	mA	24 / 48
		–	7.8	–	mA	16 / 32
		–	6.4	–	mA	8 / 16
		–	4.4	–	mA	1 / 1
Active mode current Peripherals disabled f_{MCLK} / f_{PCLK} in MHz[3]	I_{DDPAD} CC	–	6.2		mA	48 / 96
		–	4.6	–	mA	24 / 48
		–	3.6	–	mA	16 / 32
		–	3.1	–	mA	8 / 16
		–	1.8	–	mA	1 / 1
Active mode current Code execution from RAM Flash is powered down f_{MCLK} / f_{PCLK} in MHz	I_{DDPAR} CC	–	9.6	–	mA	48 / 96
Sleep mode current Peripherals clock enabled f_{MCLK} / f_{PCLK} in MHz[4]	I_{DDPSE} CC	–	11.0	–	mA	48 / 96
		–	7.6	–	mA	24 / 48
		–	6.4	–	mA	16 / 32
		–	5.3	–	mA	8 / 16
		–	4.2	–	mA	1 / 1

Table 23 Power Supply parameter table; V_{DDP} = 5V

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.[1]	Max.		
Sleep mode current Peripherals clock disabled Flash active f_{MCLK} / f_{PCLK} in MHz[5]	I_{DDPSD} CC	–	2.8	–	mA	48 / 96
		–	2.2	–	mA	24 / 48
		–	2.0	–	mA	16 / 32
		–	1.9	–	mA	8 / 16
		–	1.7	–	mA	1 / 1
Sleep mode current Peripherals clock disabled Flash powered down f_{MCLK} / f_{PCLK} in MHz[6]	I_{DDPSR} CC	–	2.2	–	mA	48 / 96
		–	1.7	–	mA	24 / 48
		–	1.4	–	mA	16 / 32
		–	1.2	–	mA	8 / 16
		–	1.1	–	mA	1 / 1
Deep Sleep mode current[7]	I_{DDPDS} CC	–	0.27	–	mA	
Wake-up time from Sleep to Active mode[8]	t_{SSA} CC	–	6	–	cycles	
Wake-up time from Deep Sleep to Active mode[9]	t_{DSA} CC	–	290	–	µsec	

1) The typical values are measured at T_A = + 25 °C and V_{DDP} = 5 V.
2) CPU and all peripherals clock enabled, Flash is in active mode.
3) CPU enabled, all peripherals clock disabled, Flash is in active mode.
4) CPU in sleep, all peripherals clock enabled and Flash is in active mode.
5) CPU in sleep, Flash is in active mode.
6) CPU in sleep, Flash is powered down and code executed from RAM after wake-up.
7) CPU in sleep, peripherals clock disabled, Flash is powered down and code executed from RAM after wake-up.
8) CPU in sleep, Flash is in active mode during sleep mode.
9) CPU in sleep, Flash is in powered down mode during deep sleep mode.

3.3.3 On-Chip Oscillator Characteristics

Table 27 provides the characteristics of the 96 MHz digital controlled oscillator DCO1.

Note: These parameters are not subject to production test, but verified by design and/or characterization.

Table 27 96 MHz DCO1 Characteristics (Operating Conditions apply)

Parameter	Symbol		Limit Values			Unit	Test Conditions
			Min.	Typ.	Max.		
Nominal frequency	f_{NOM}	CC	–	96	–	MHz	under nominal conditions[1] after trimming
Accuracy with adjustment based on XTAL as reference	Δf_{LTX}	CC	-0.3	–	0.3	%	with respect to f_{NOM}(typ), over temperature (-40 °C to 105 °C)
Accuracy	Δf_{LT}	CC	-1.7	–	3.4	%	with respect to f_{NOM}(typ), over temperature (0 °C to 85 °C)
			-3.9	–	4.0	%	with respect to f_{NOM}(typ), over temperature (-40 °C to 105 °C)

1) The deviation is relative to the factory trimmed frequency at nominal V_{DDC} and T_A = + 25 °C.

Table 28 provides the characteristics of the 32 kHz digital controlled oscillator DCO2.

Table 28 32 kHz DCO2 Characteristics (Operating Conditions apply)

Parameter	Symbol		Limit Values			Unit	Test Conditions
			Min.	Typ.	Max.		
Nominal frequency	f_{NOM}	CC	–	32.75	–	kHz	under nominal conditions[1] after trimming
Accuracy	Δf_{LT}	CC	-1.7	–	3.4	%	with respect to f_{NOM}(typ), over temperature (0 °C to 85 °C)
			-3.9	–	4.0	%	with respect to f_{NOM}(typ), over temperature (-40 °C to 105 °C)[1]

1) The deviation is relative to the factory trimmed frequency at nominal V_{DDC} and T_A = + 25 °C.

4.2 Package Outlines

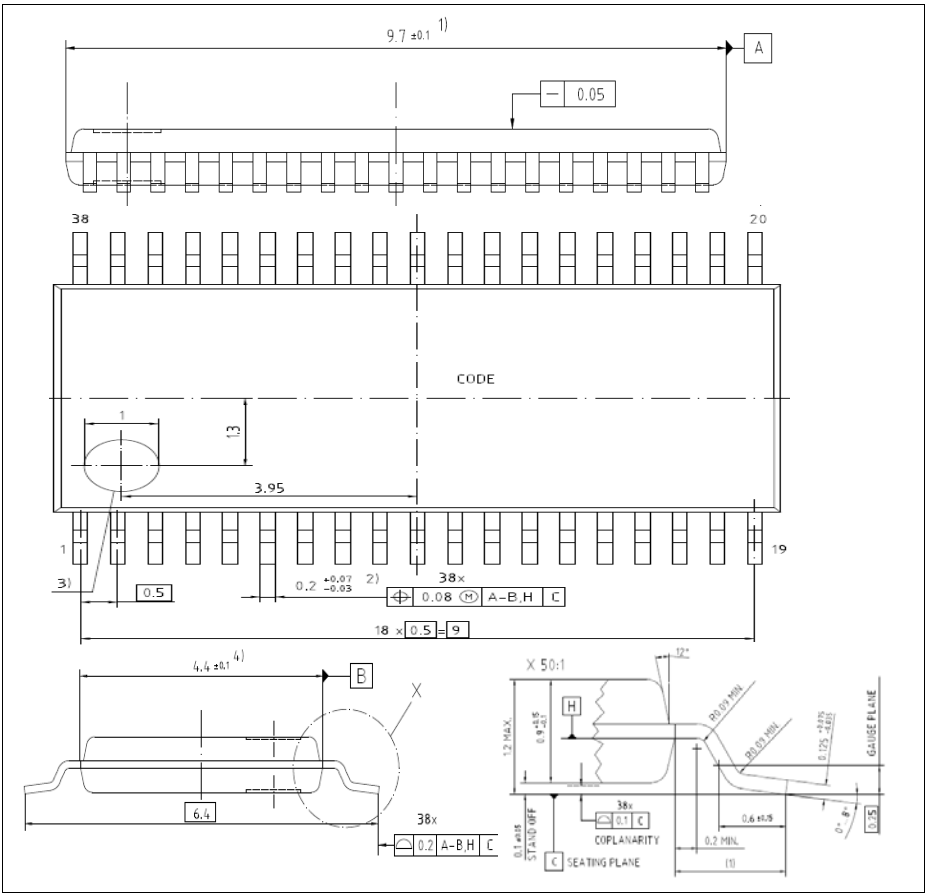

Figure 29 PG-TSSOP-38-9